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FDMD8260L Dual N-Channel Power Trench[®] MOSFET

60 V, 5.8 mΩ

Features

- Max $r_{DS(on)}$ = 5.8 m Ω at V_{GS} = 10 V, I_D = 15 A
- Max $r_{DS(on)}$ = 8.7 m Ω at V_{GS} = 4.5 V, I_D = 12 A
- Ideal for Flexible Layout in Primary Side of Bridge Topology
- 100% UIL Tested
- Kelvin High Side MOSFET Drive Pin-out Capability
- Termination is Lead-free and RoHS Compliant

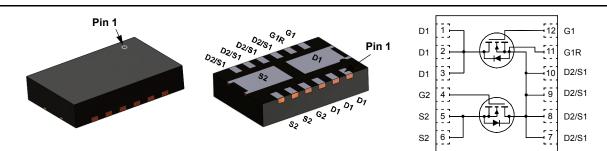


General Description

This device includes two 60V N-Channel MOSFETs in a dual Power (3.3 mm X 5 mm) package. HS source and LS Drain internally connected for half/full bridge, low source inductance package, low $r_{DS(on)}/Qg$ FOM silicon.

Applications

- Synchronous Buck : Primary Switch of Half / Full bridge Converter for Telecom
- Motor Bridge : Primary Switch of Half / Full bridge Converter for BLDC Motor
- MV POL : 48V Synchronous Buck Switch



Power 3.3 x 5

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Param	neter		Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	64		
	-Continuous	T _C = 100 °C	(Note 5)	40	•	
ID	-Continuous	T _A = 25 °C	(Note 1a)	15	Α	
	-Pulsed		(Note 4)	293		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	181	mJ	
-	Power Dissipation	T _C = 25 °C		37		
PD	Power Dissipation	T _A = 25 °C	(Note 1a)	2.1	W	
	Power Dissipation	T _A = 25 °C	(Note 1b)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temper	ature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		3.4	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	60	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	130	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
8260L	FDMD8260L	Power 3.3 x 5	13 "	12 mm	3000 units

FDMD8260L
Dual
N-Channel
PowerTrench [®]
MOSFET

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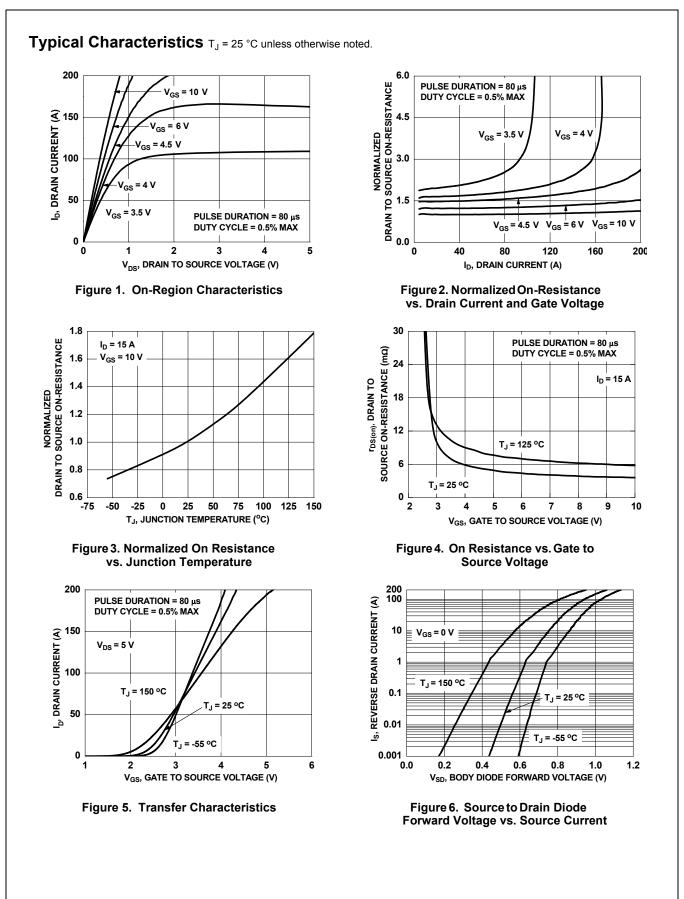
	Parameter	Test Conditions	Min.	Тур.	Max.	Units
	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60			V
ΔBV_{DSS} ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		33		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.5	3.0	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 15 A		4.5	5.8	mΩ
	Static Drain to Source On Resistance	$V_{GS} = 4.5 V, I_D = 12 A$		6.6	8.7	
00(01)		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		5.9	7.8	
9 _{FS}	Forward Transconductance	$V_{DD} = 5 V, I_D = 15 A$		56		S
Jynamic	Characteristics					
C _{iss}	Input Capacitance			3745	5245	pF
C _{oss}	Output Capacitance	$-V_{DS} = 30 V, V_{GS} = 0 V$		558	785	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		22	50	pF
R _g	Gate Resistance		0.1	3.0	6.0	Ω
*						
-	Turn-On Delay Time			10	21	
•				12	21	ns
	,			10	20	
t <mark>r</mark>	Rise Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		10	20	ns
t _r t _{d(off)}	Rise Time Turn-Off Delay Time	V_{DD} = 30 V, I _D = 15 A V _{GS} = 10 V, R _{GEN} = 6 Ω		47	74	ns
t _r t _{d(off)}	Rise Time Turn-Off Delay Time Fall Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		47 11	74 20	ns ns
t _r t _{d(off)} t _f	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		47 11 49	74 20 68	ns ns nC
t <u>r</u> td(off) tf Q _{g(TOT)}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$		47 11 49 25	74 20	ns ns nC nC
t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		47 11 49 25 8.6	74 20 68	ns ns nC nC nC
t <mark>r t_{d(off)} t_f Q_{g(TOT)} Q_{gs}</mark>	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$		47 11 49 25	74 20 68	ns ns nC nC
t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$ $I_{D} = 15 \text{ A}$		47 11 49 25 8.6	74 20 68	ns ns nC nC nC
t _r t _{d(off)} t Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So t	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 30 \text{ V}$ $I_D = 15 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 15 \text{ A}$ (Note 2)		47 11 49 25 8.6	74 20 68	ns ns nC nC nC
t _r t _{d(off)} t Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So t	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge urce Diode Characteristics Source to Drain Diode Forward Voltage	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$ $I_{D} = 15 \text{ A}$		47 11 49 25 8.6 5.2	74 20 68 35 1.3 1.2	ns ns nC nC nC nC
t _{d(on)} t <u>r</u> Q _{g(TOT)} Q _{gs} Q _{gd} Drain-Sou V _{SD} Q _{rr}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 30 \text{ V}$ $I_D = 15 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 15 \text{ A}$ (Note 2)		47 11 49 25 8.6 5.2 0.8	74 20 68 35 1.3	ns ns nC nC nC nC

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Electrical Characteristics T_J = 25 °C unless otherwise noted.

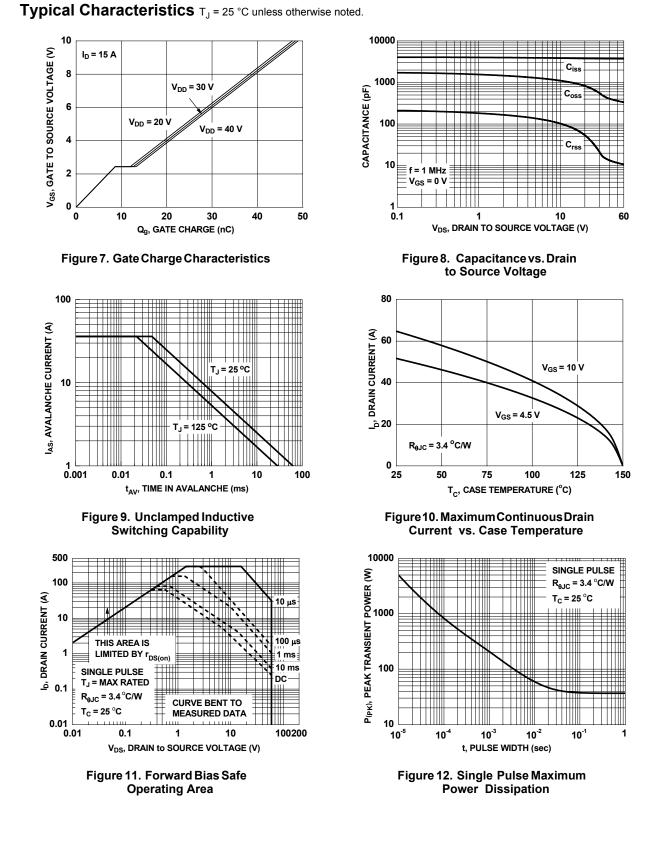
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

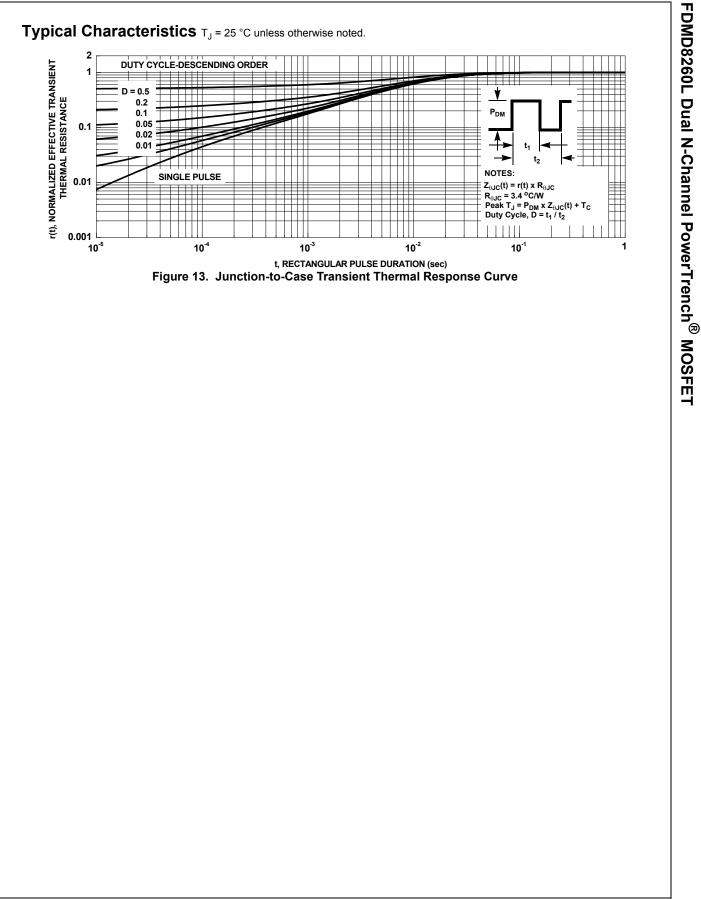
2. Pulse fest. Pulse when < 500 µs, puls goue < 2.0 m. 3. E_{AS} of 181 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 11 A, V_{DD} = 60 V, V_{GS} = 10 V. 100% tested at L = 0.1 mH, I_{AS} = 36 A. 4. Pulsed Id please refer to Fig 11 SOA graph for more details. 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



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